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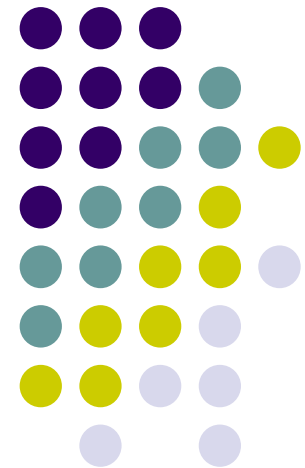
Optimizing the Architecture of SFQ-RDP (Single Flux Quantum-Reconfigurable Datapath)

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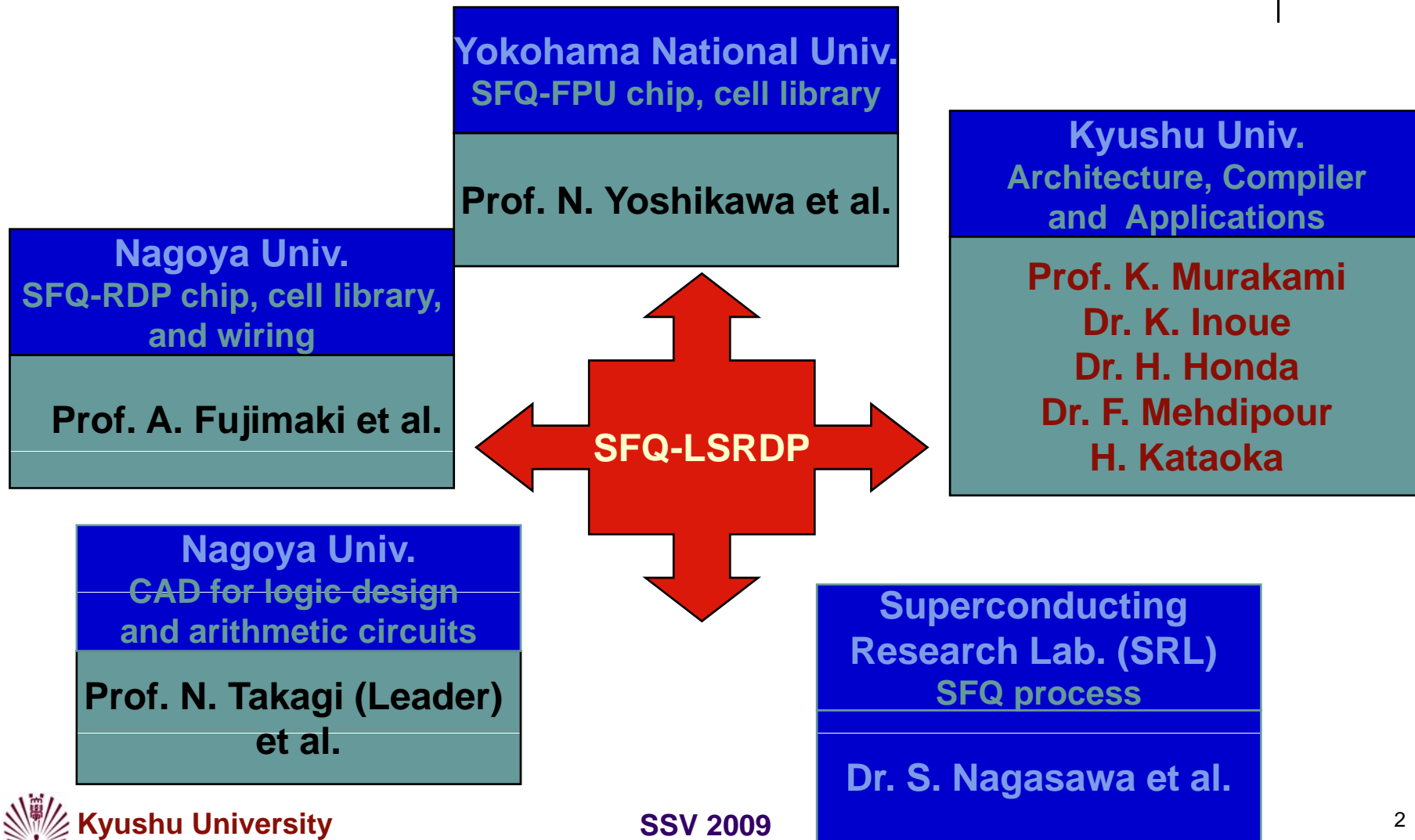
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CREST-JST (2006~): Low-power, high-performance, reconfigurable processor using single-flux quantum circuits



Agenda



- Introduction
- Large-Scale Reconfigurable Data-Path (LSRDP)
General Architecture and Specifications
- Design Procedure and Tool Chain
- Preliminary Results
- Conclusions and Future Work

Introduction



- For performance improvement various accelerators are used with GPPs
 - PowerXcell, GPU, GRAPE-DR, ClearSpeed, etc.
 - Small size and low power consumption comparing to processors with similar performance

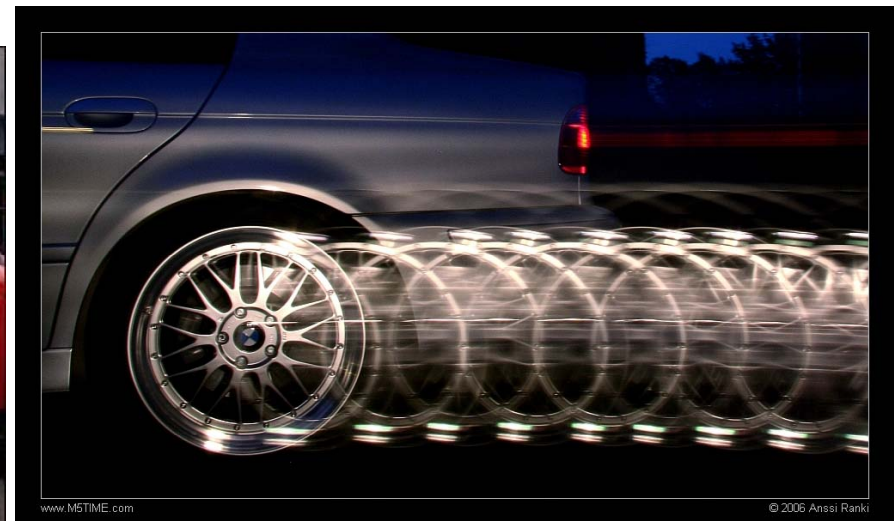


NVIDIA Tesla S1070
<http://www.nvidia.com>

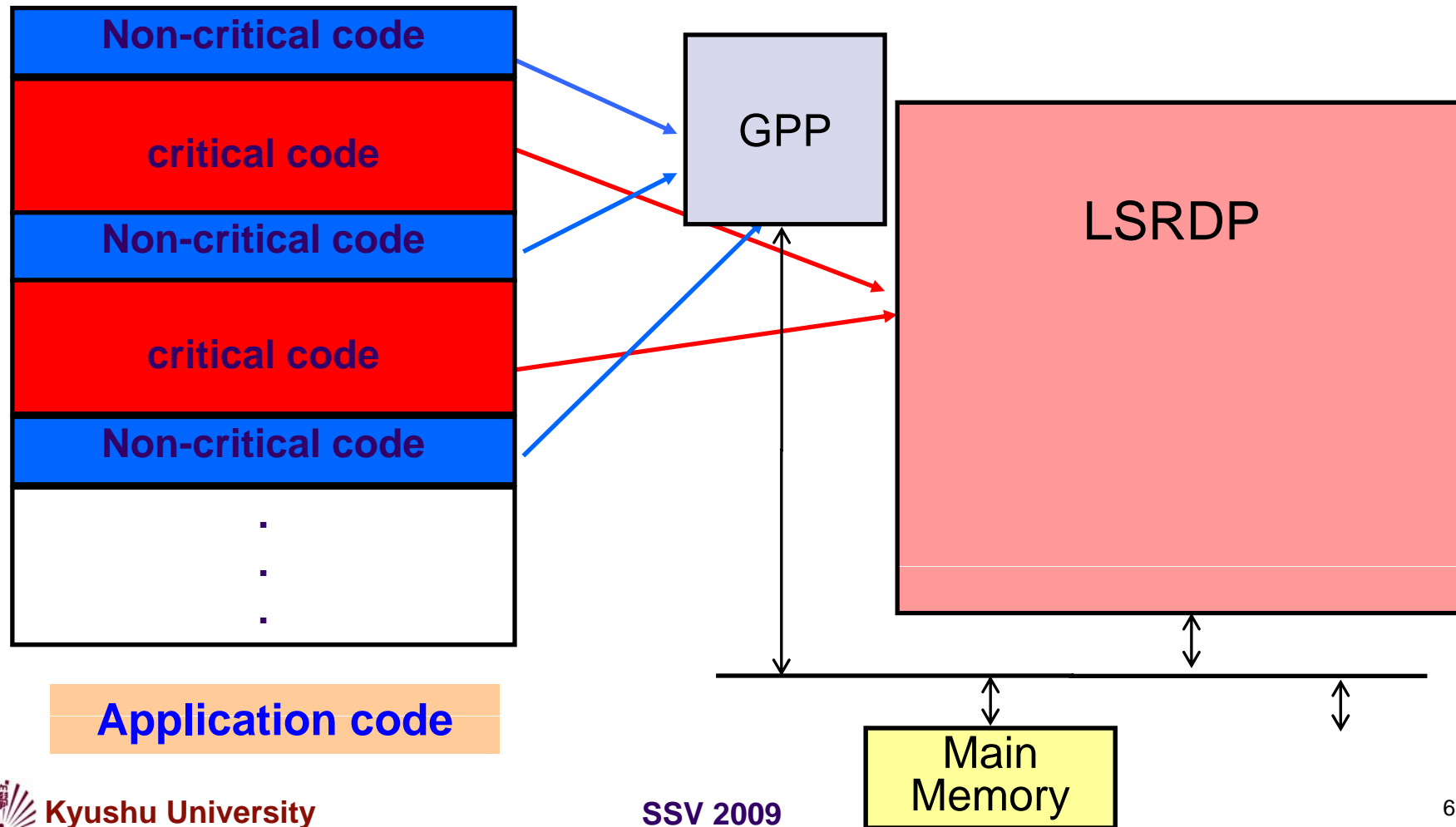
Acceleration Through a Data-Path Processor



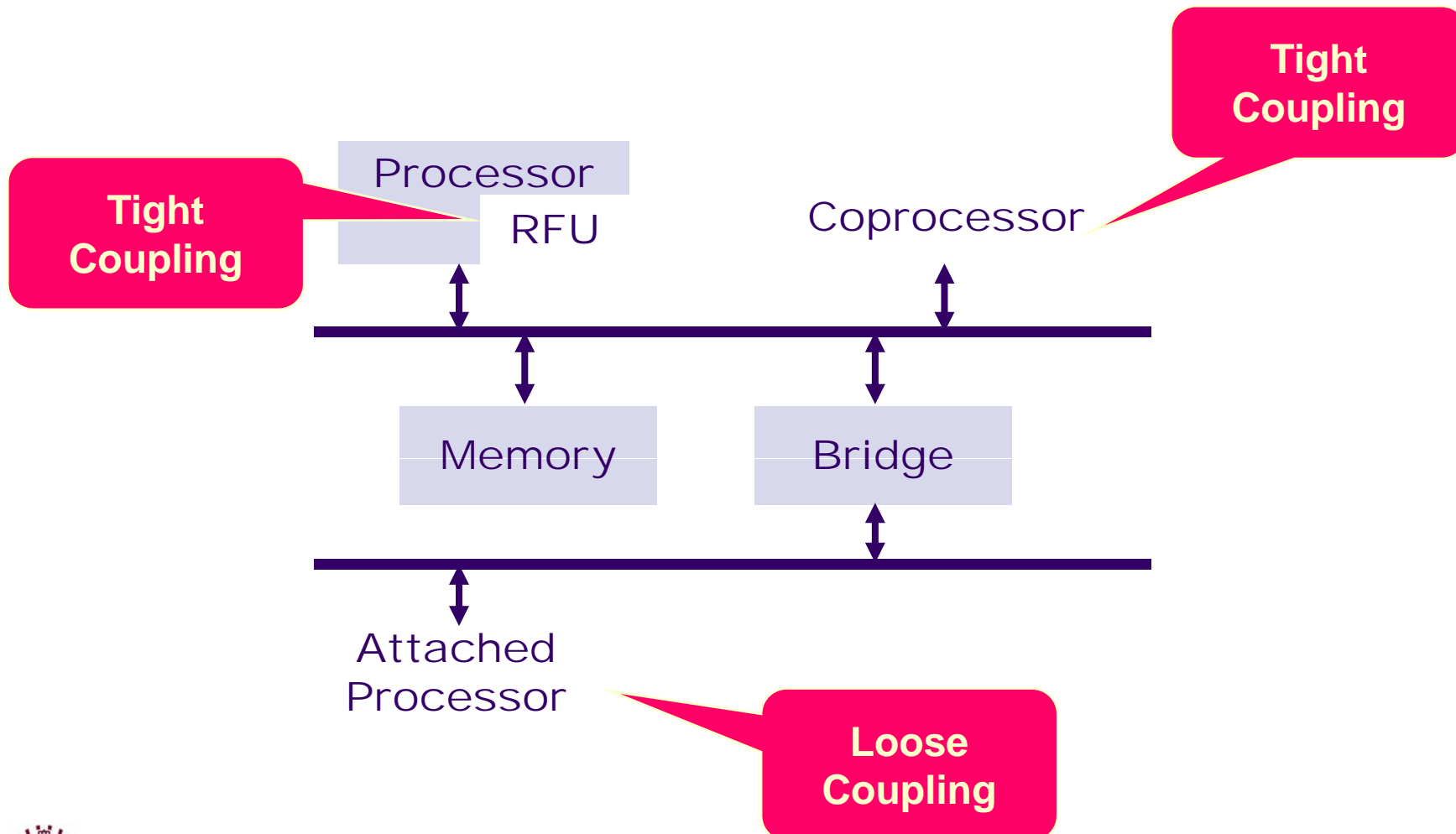
- Mechanism
 - Acceleration by using a data-path accelerator
 - Augmenting the accelerator to the base processor
 - Executes hot portions of applications on the accelerator



How a Reconfigurable Processor Works



Coupling an Accelerator to a Processor

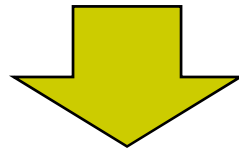


Motivation



Conventional accelerators:

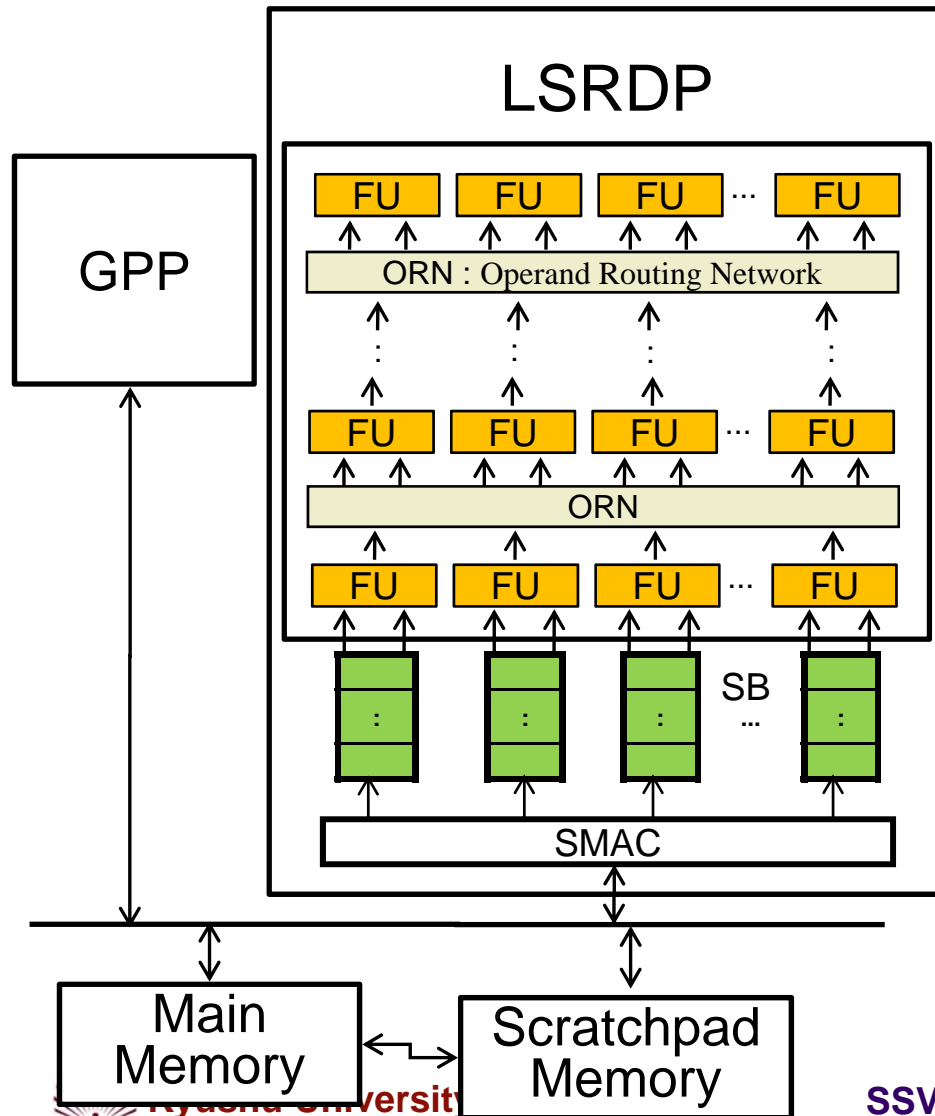
- A large memory bandwidth is demanded in conventional accelerators for high-performance computation
- On chip memories are often used to hide memory access latency



Large-Scale Reconfigurable Data-Path (LSRDP):

- is introduced as an alternative accelerator
- reduces the no. of memory accesses by utilizing data-path

Outline of Large-Scale Reconfigurable Data-Path (LSRDP) processor



- Reconfigurable data-path includes:

- A large number of floating point Functional Units (FUs) Arranged as arrays
- Reconfigurable Operand Routing Network : (ORN)
- Dynamic reconfiguration facilities
- Streaming Buffer (SB) for I/O ports

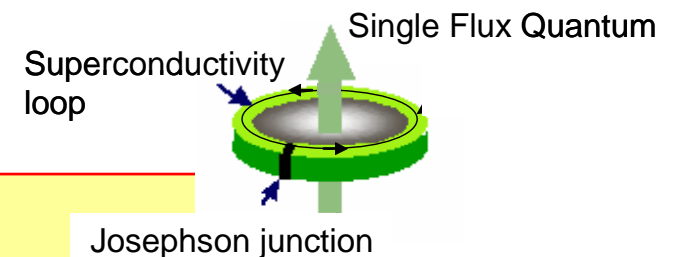
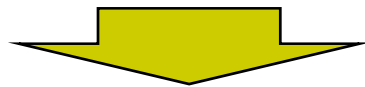
- Features:

- Data Flow Graphs (DFGs) extracted from critical calculation parts are directly mapped
- Pipeline execution
- Burst transfer is used for input /output rearranged data from/to memory

Single-Flux Quantum (SFQ) against CMOS



- CMOS issues: (*if LSRDP has 32x32 FUs*)
 - high electric power consumption
 - high heat radiation and difficulties in high-density packing



- SFQ Features:
 - **High-speed switching** and signal transmission
 - **Low power consumption**
 - Compact implementation of a system (small area)
 - No cost for latch
 - Suitable for pipeline processing of data stream
 - **Serial bit-level processing**

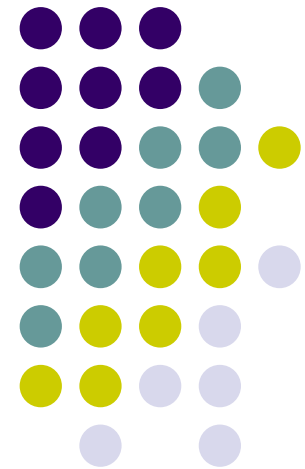
Goals of the Project



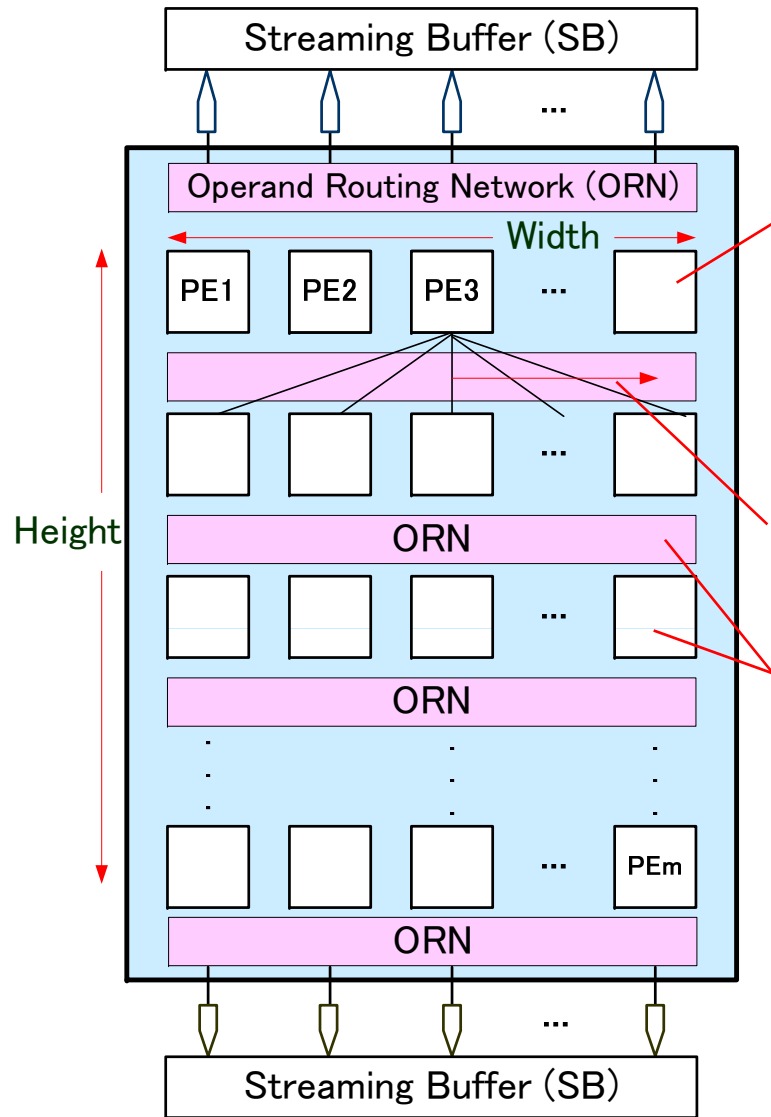
- Discovering appropriate scientific applications
- Developing compiler tools
- Developing performance analyzing tools

Designing and Implementing SFQ-LSRDP architecture considering the features and limitations of SFQ circuits

LSRDP General Architecture and Specifications



Parameters Should Be Decided Within the LSRDP Design Procedure



- Core structure: a rectangular matrix of PEs
- PE: combination of a Functional Unit (FU) and a data Transfer Unit (TU)

Width and Height ?

Maximum Connection Length (MCL) between consecutive rows?
(impossible to implement full cross bar)

Layout: FU types
(ADD/SUB and MUL)?

Reconfiguration mechanism?
(PE, ORN, Immediate data)

- On-chip memory configuration?

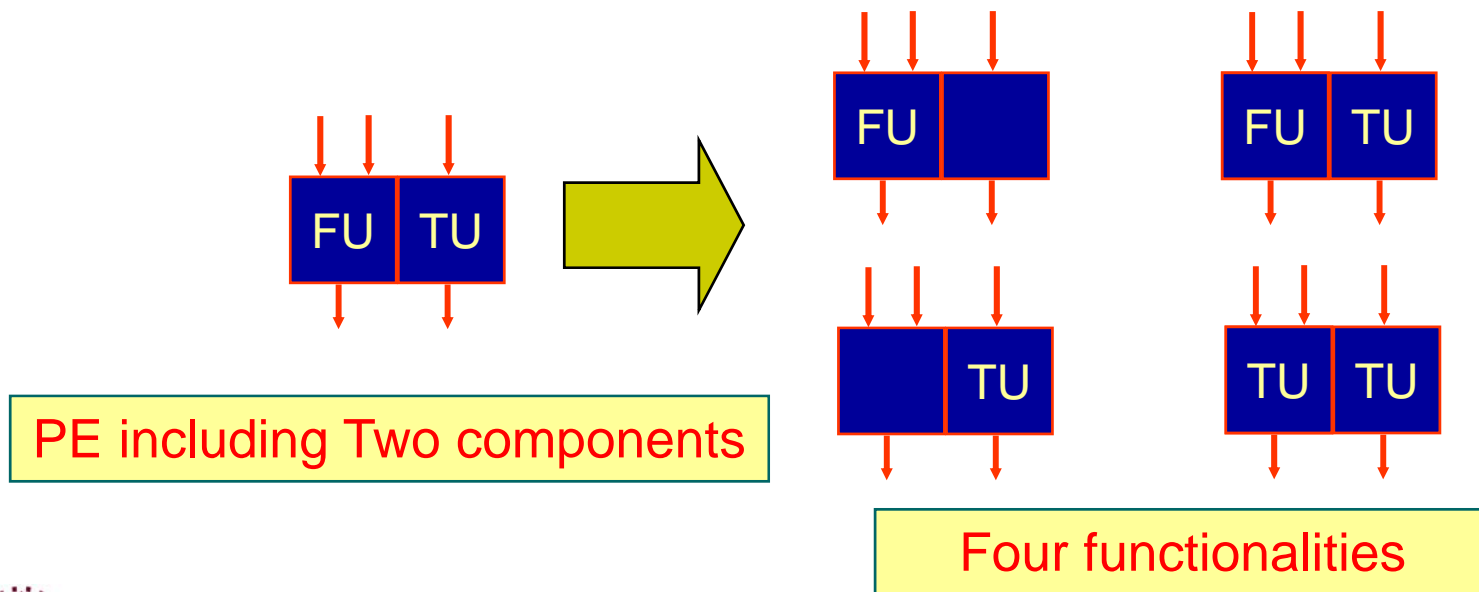


LSRDP Architecture

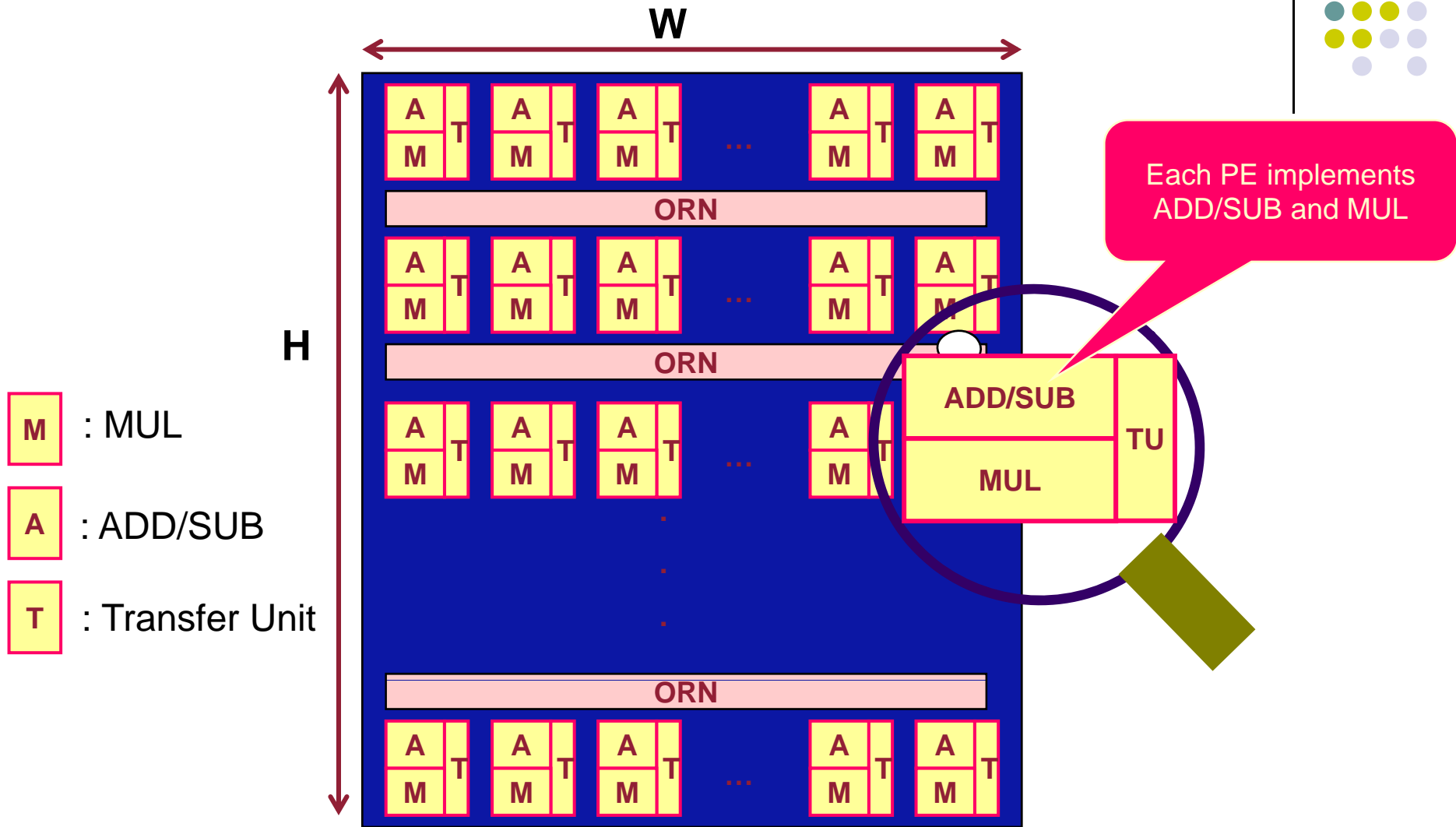


- **Processing Elements**

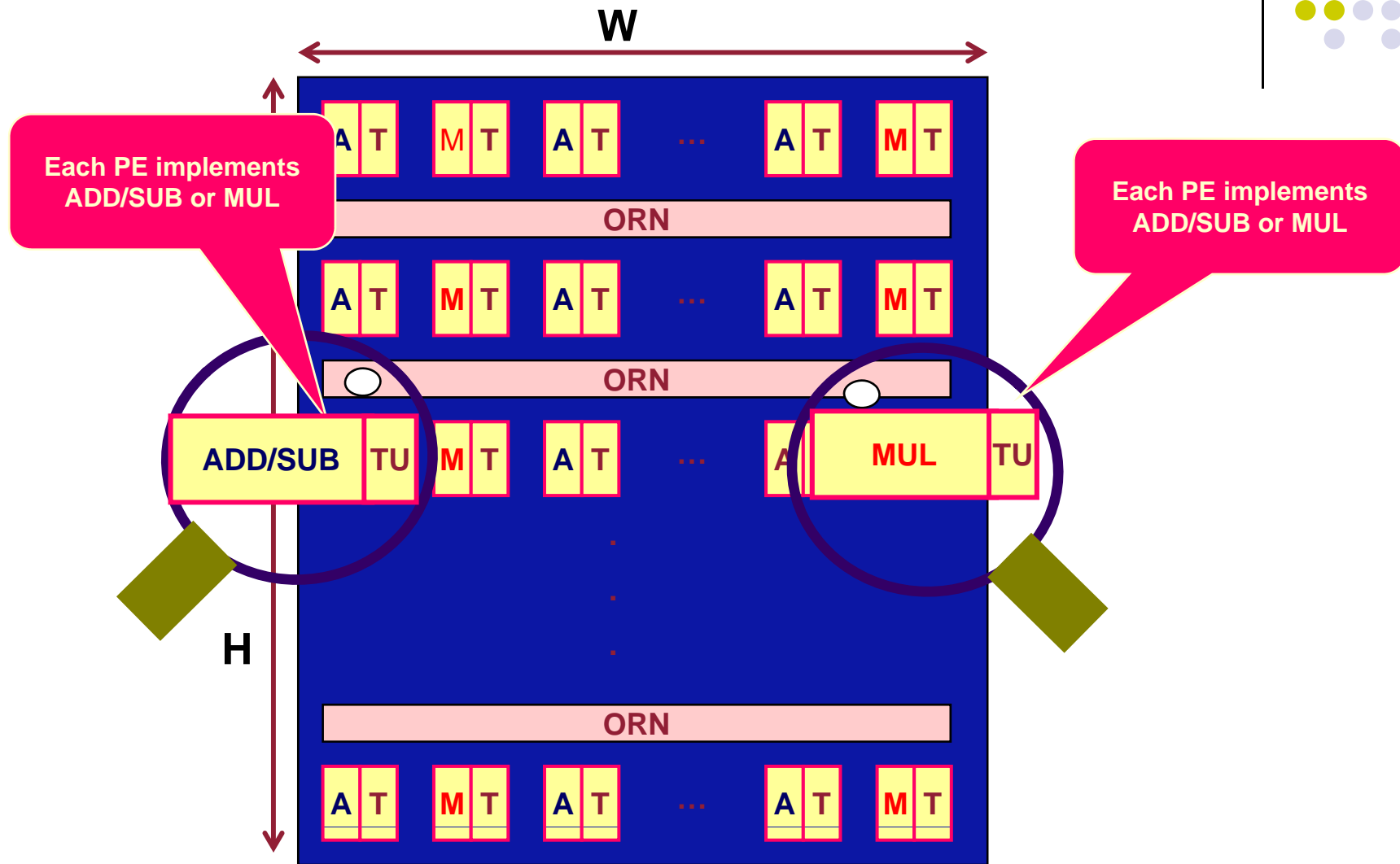
- FU
 - implements basic 64-bit double-precision floating point operations including: **ADD, SUB and MUL**
- TU (transfer unit) as a routing resource for transferring data from a row to an inconsecutive row



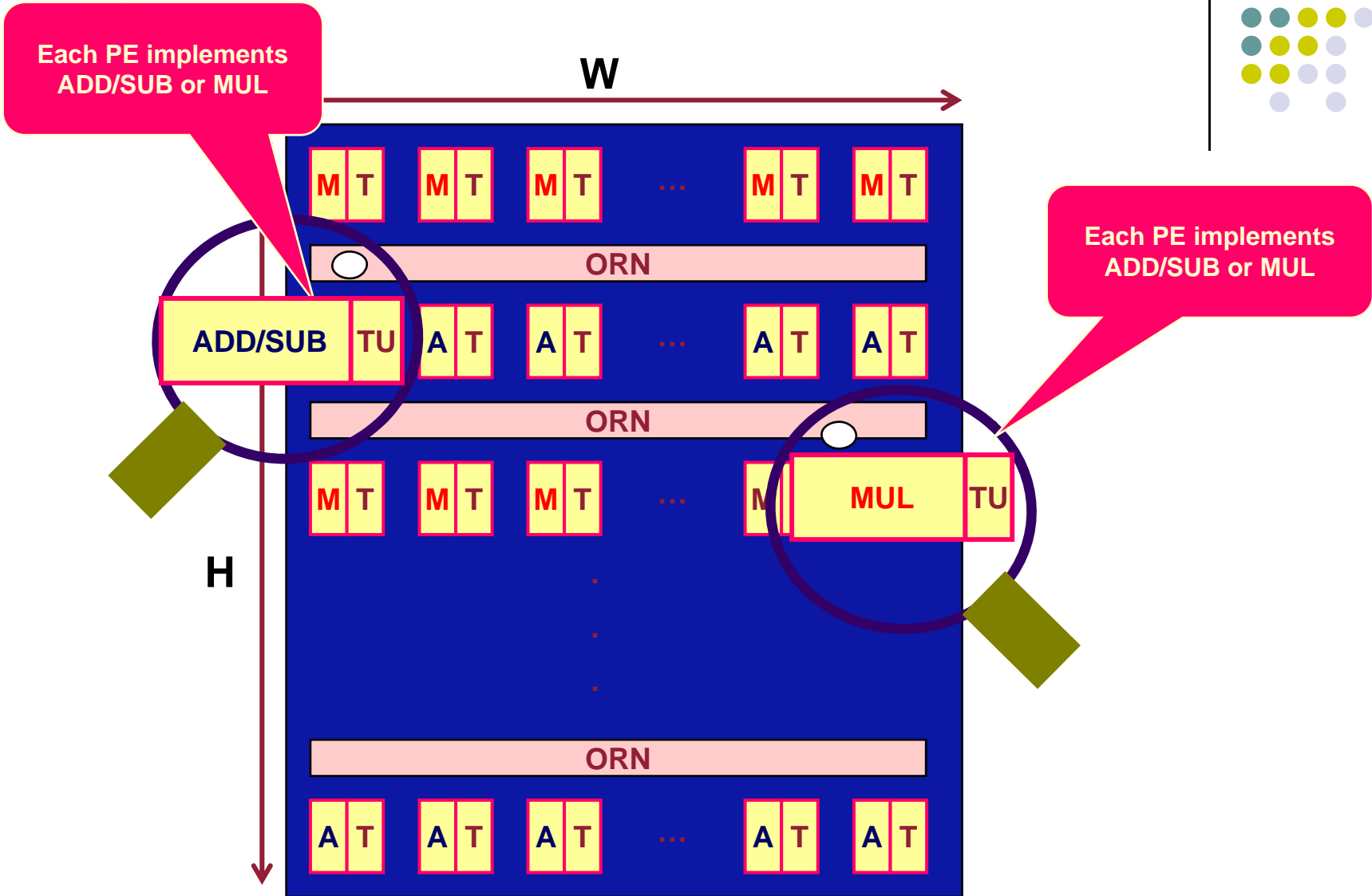
Layout Types- Type I



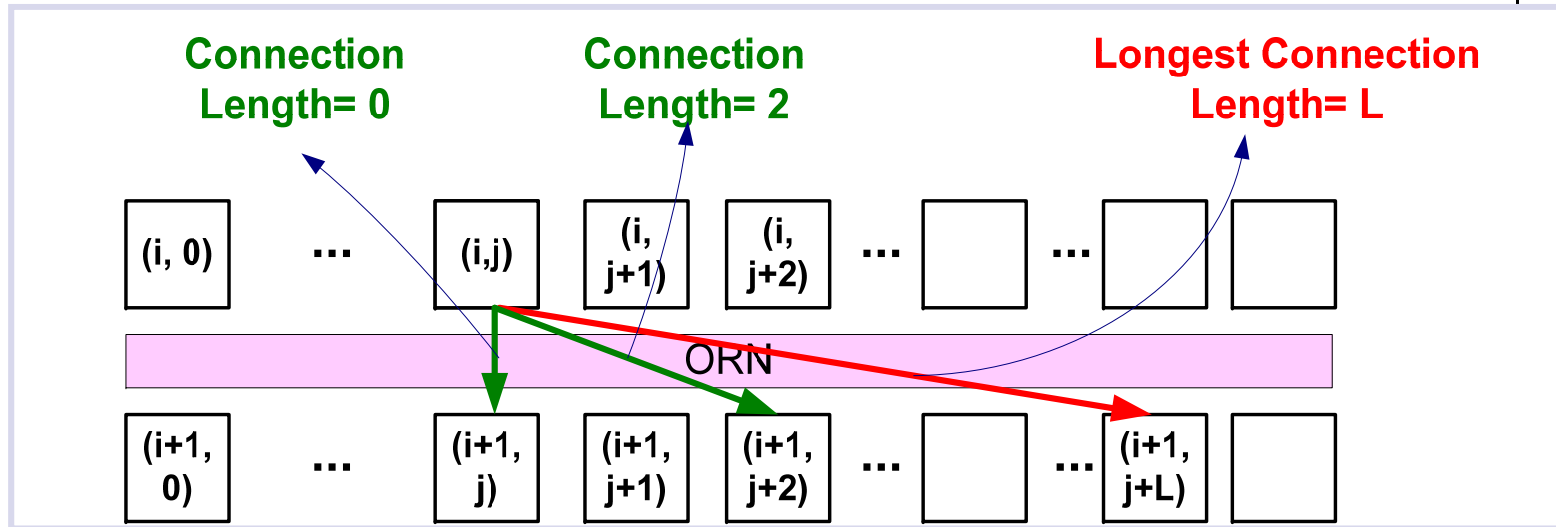
Layout Types- Type II (Checked)



Layout Types- Type III (Striped)



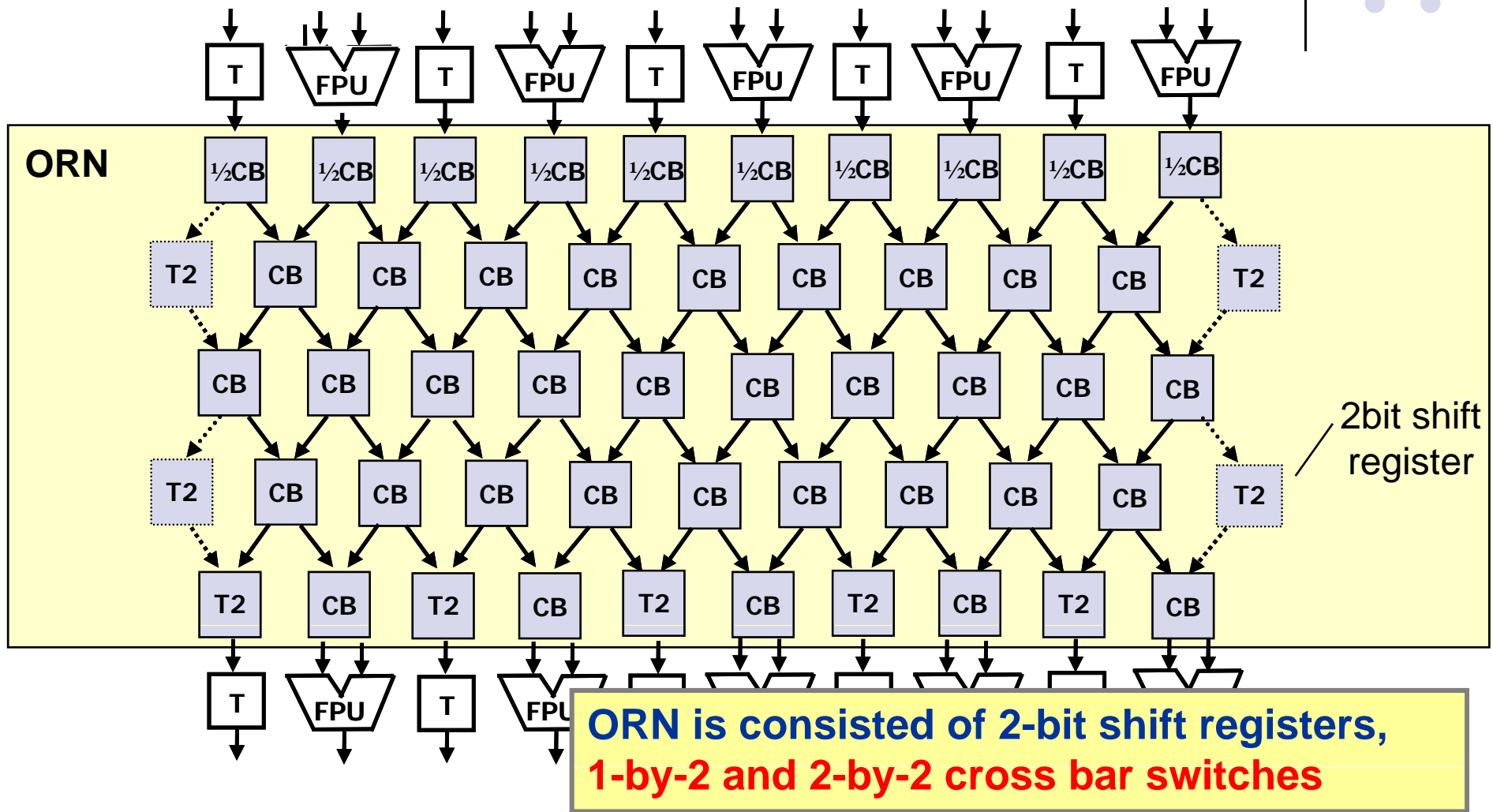
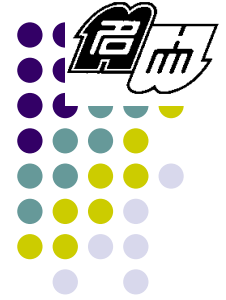
Maximum Connection Length (MCL)



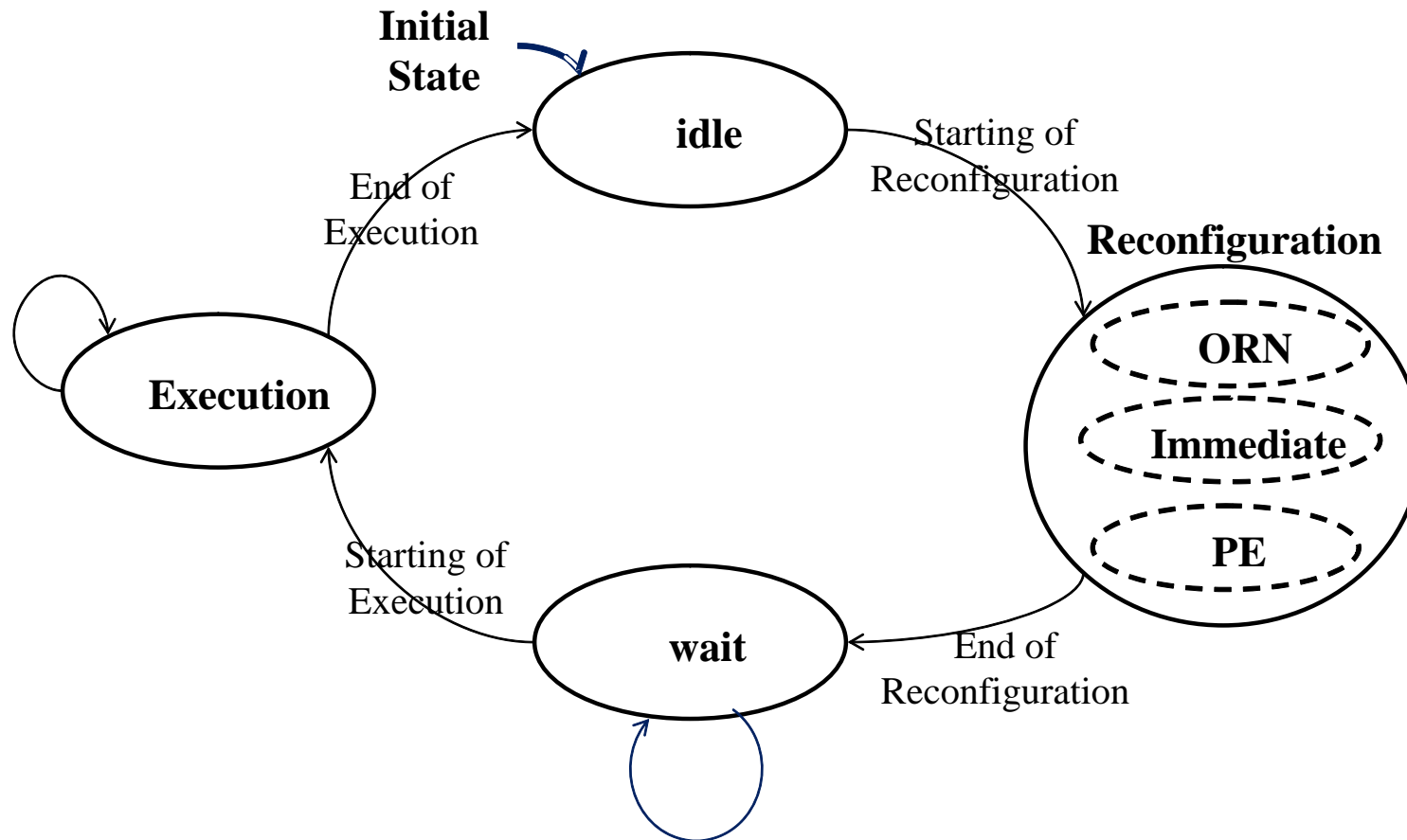
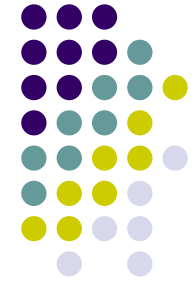
MCL:

maximum horizontal distance
between two PEs located in two subsequent rows

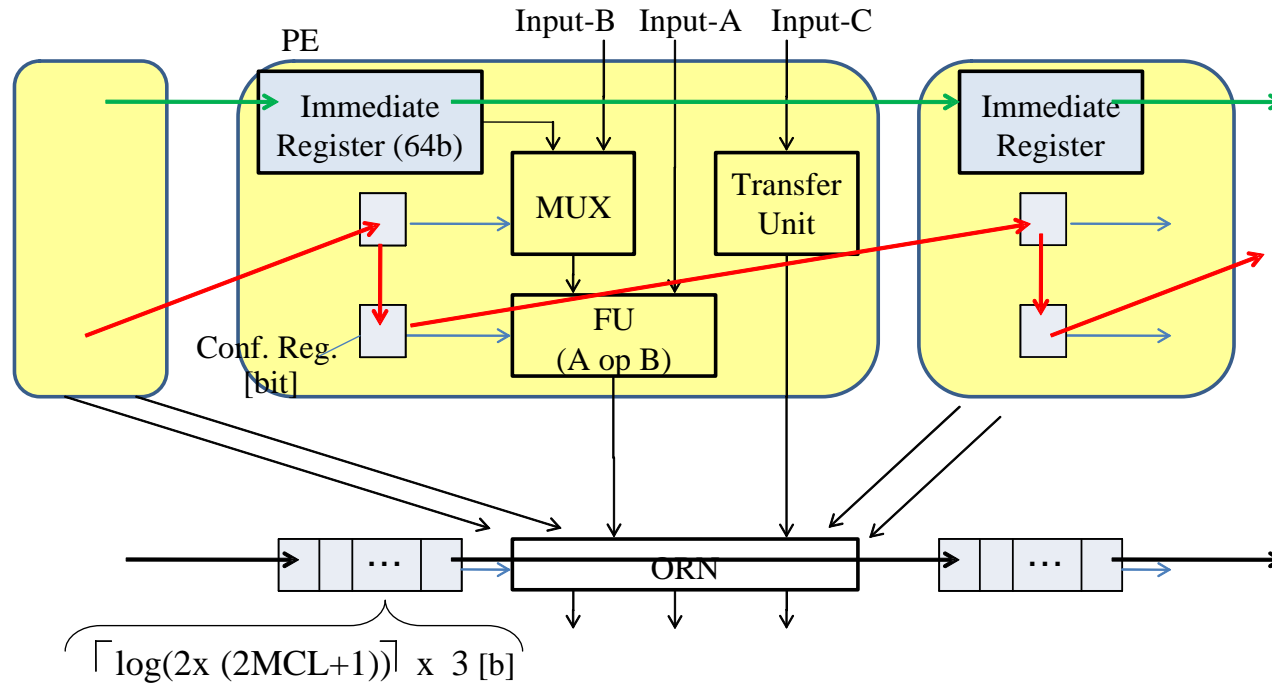
An ORN Structure



Dynamic Reconfiguration Mechanism



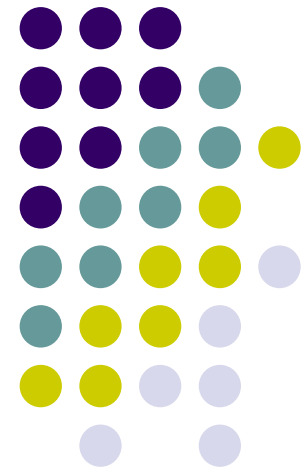
Dynamic Reconfiguration Architecture



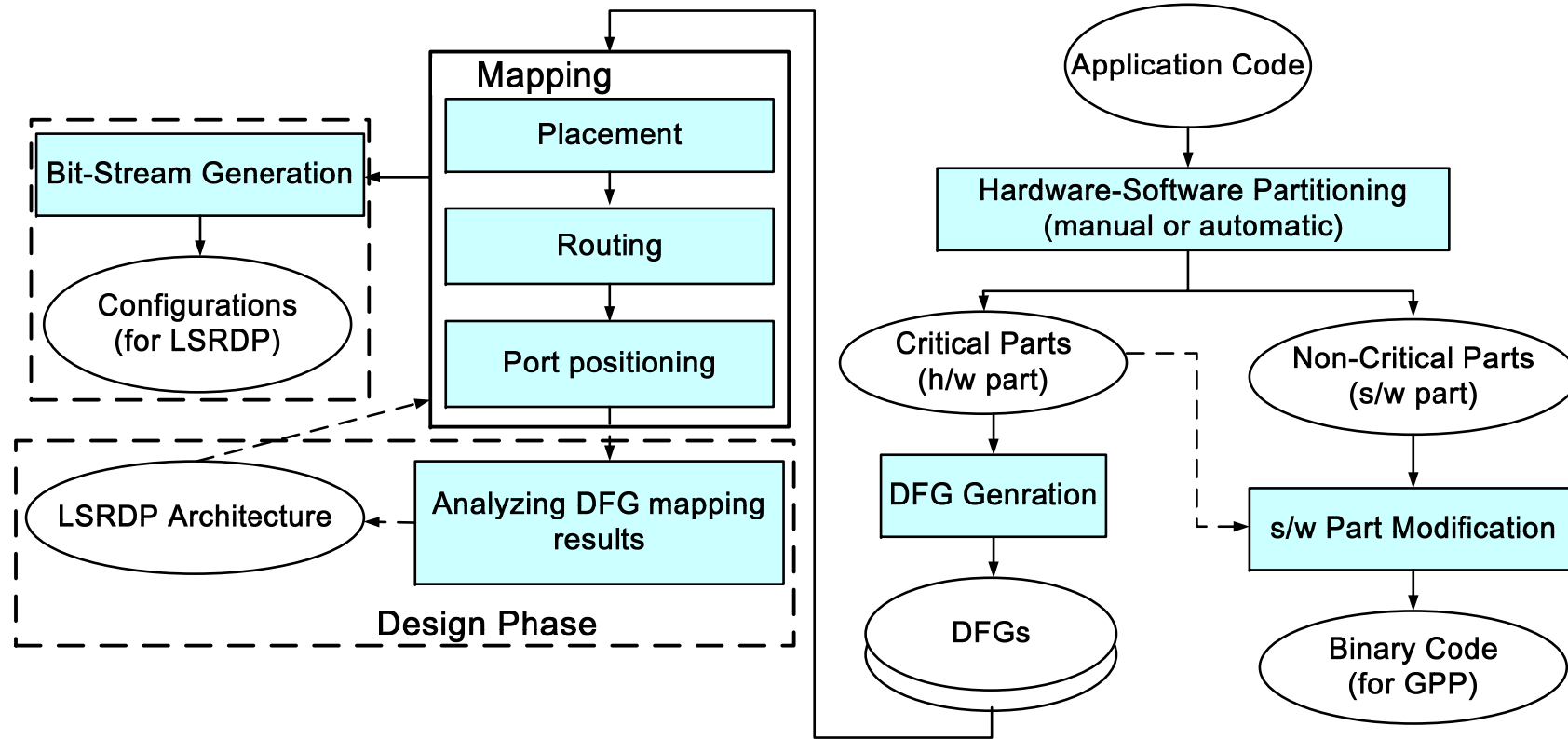
Three bit-stream lines for dynamic reconfiguration of:

- Immediate registers (64bit) in each PE
- Selector bits for muxes selecting the input data of FUs
- Cross-bar switches in ORNs

Design Procedure and Tool Chain



Compiler and Design Flow



- DFGs are manually generated from critical parts of applications
- DFG mapping results are used for
 - Analyzing LSRDP architecture statistics
 - Generating LSRDP configuration bit-streams



Benchmark Applications for Design Procedures



- Finite differential method calculation of 2nd order partial differential equations
 - 1dim-Heat equation (Heat)
 - 1dim-Vibration equation (Vibration)
 - 2dim-Poisson equation (Poisson)
- Quantum chemistry application
 - Recursive parts of Electron Repulsion Integral calculation (ERI-Rec)

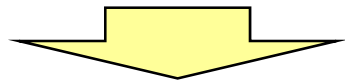
**Only ADD/SUB and MUL operations are used
in the critical calculations of all above applications**

DFG Extraction- Heat Equation



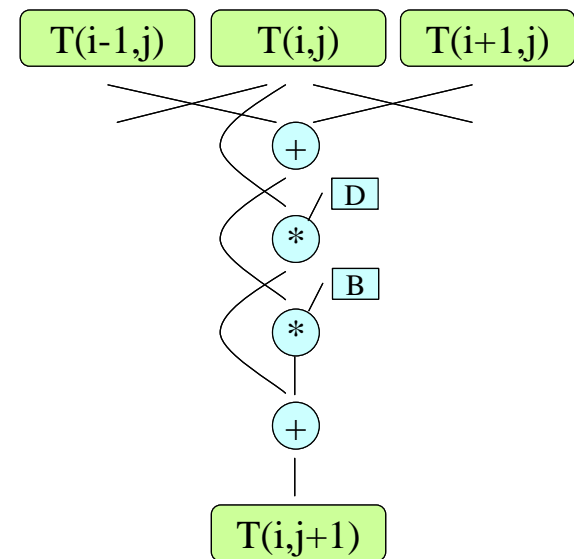
- 1-dim. heat equation for $T(x,t)$

$$\frac{\partial T(x,t)}{\partial t} = A \frac{\partial^2 T(x,t)}{\partial x^2} \quad (A \text{ is const.})$$



- Calculation by Finite Difference Method (FDM)

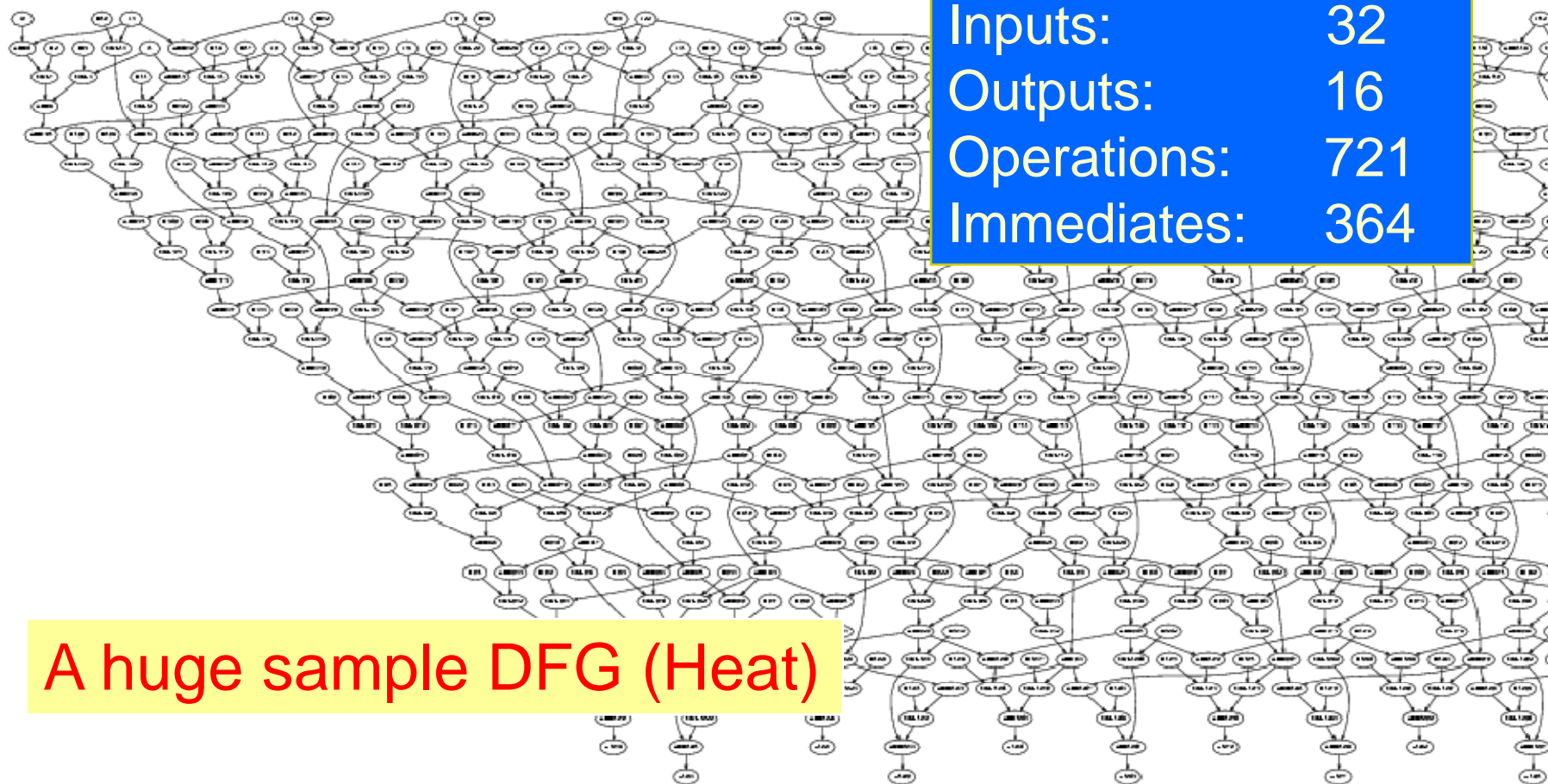
$$T(x_i, t_{j+1}) = D * T(x_i, t_j) + B * [T(x_{i-1}, t_j) + T(x_{i+1}, t_j)]$$



Basic DFG can be extended to horizontal and vertical directions to make a larger DFG

Basic DFG corresponding to minimum FDM calculation

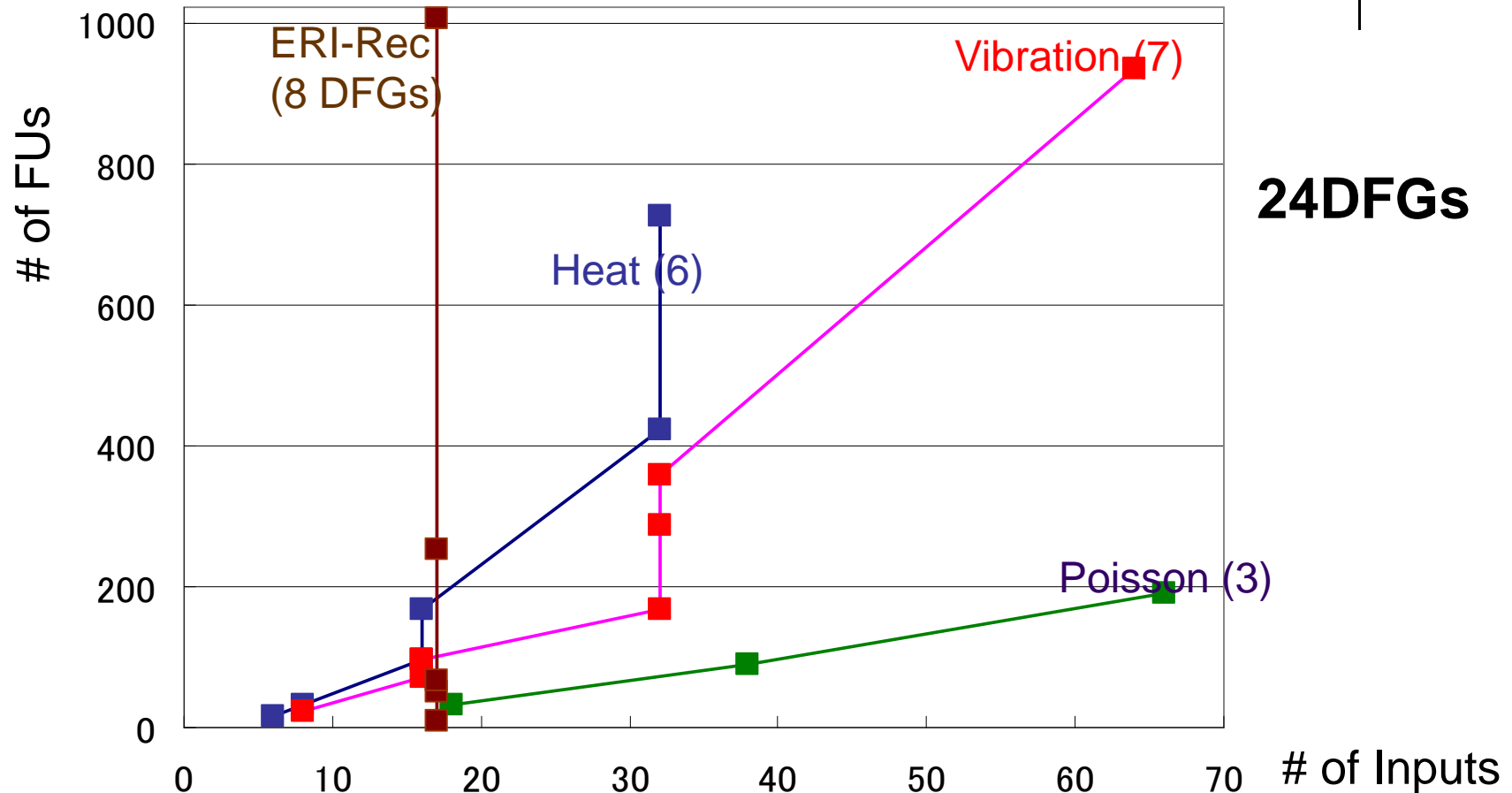
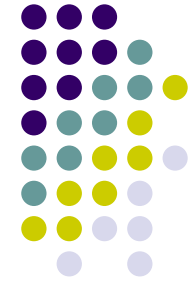
Example of extracted DFGs- Heat



Inputs: 32
Outputs: 16
Operations: 721
Immediates: 364

A huge sample DFG (Heat)

DFG Distribution for each application



24DFGs

DFGs have different qualities in terms of the # of FUs, # of Inputs and Outputs

DFG Classification

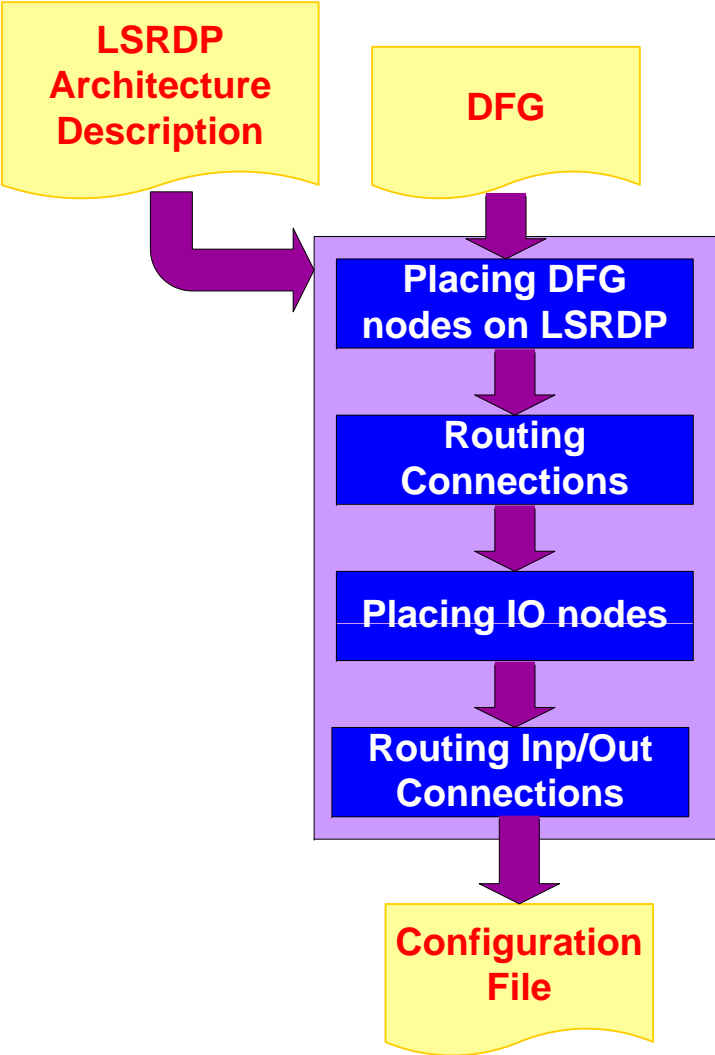


Class	# of FUs	# of Inputs	# of Outputs	# of DFGs
RDP-S	128	19	12	Heat (3) Poi (1) Vib (2) Eri (4)
RDP-M	512	19	12	Heat (1) Poi (1) Vib (1) Eri (4)
RDP-L	1024	38	24	Heat (2) Poi (1) Vib (2) Eri (5)
RDP-XL	> 1024	64	52	Heat (1) Poi (1) Vib (2) Eri (5)

Totally,
24 DFGs are prepared
for benchmark Apps.

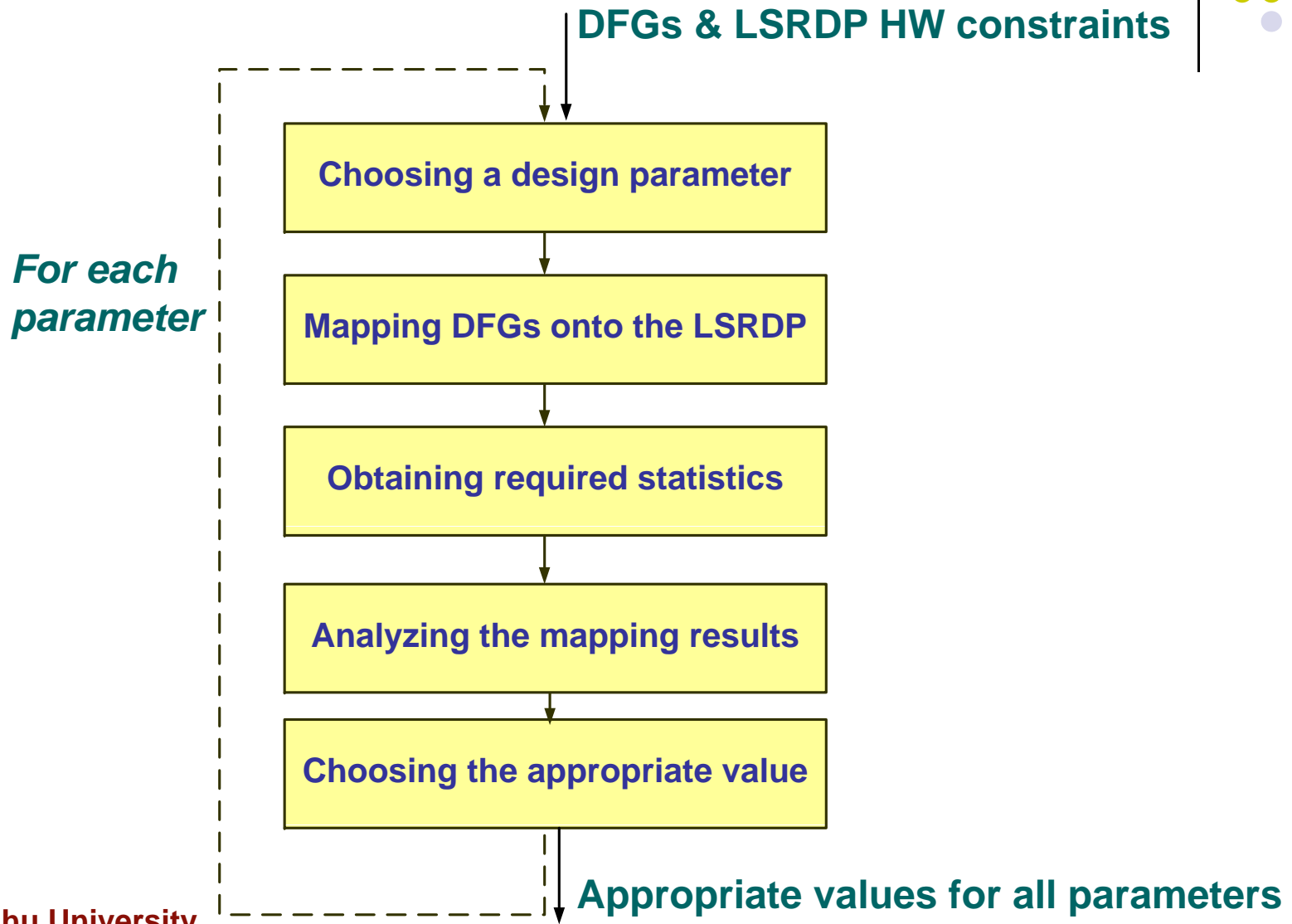
Due to broad range of DFG sizes
DFGs are classified as S, M, L, XL with respect to their size
and the number of Input/Output nodes
=> LSRDP designing processes for S, M, L, XL, respectively

Mapping DFGs onto LSRDP

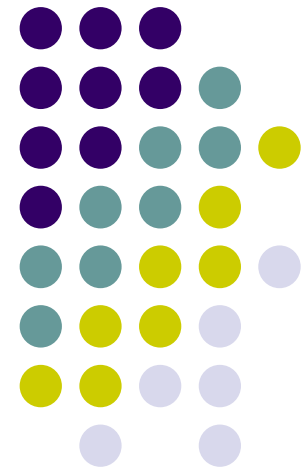


Longest connections

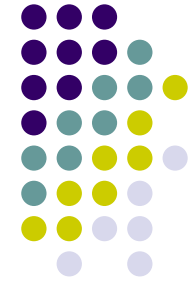
LSRDP Design Procedure



Preliminary Results



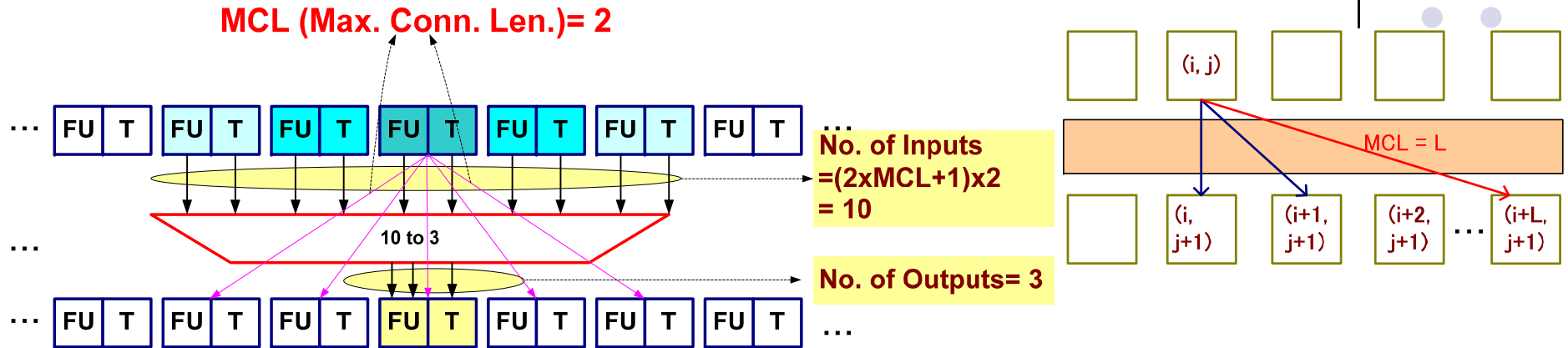
LSRDP Specifications: Width & Height



	# of Input ports	# of Output ports	Width	Height
LSRDP-S	19	12	16	16
LSRDP-M	19	12	32	16
LSRDP-L	38	24	64	32

LSRDP Dimensions and the number of input/output ports

LSRDP Specifications: MCL



LSRDP	MCL (avg/max)	ORN Size- No of Inps (avg/max), Outs
LSRDP-S	4/8	18/34, 3
LSRDP-M	5/9	22/38, 3
LSRDP-L	5/9	22/34, 3



Analyzing Various LSRDP Layouts



	Layout	Size
Heat	I	8x3
	II	8x3
	III	8x4
Viriation	I	10x8
	II	10x8
	III	10x11
Poisson	I	10x10
	II	10x12
	III	15x18
ERI1	I	6x2
	II	9x3
	III	6x2
ERI2	I	10x10
	II	10x10
	III	15x8

Layout I \simeq Layout II

(Except ERI1 DFG which gives better size for Layout III)

Layout II can be used instead of Layout I to obtain a smaller LSRDP



LSRDP at One Glance (1/2)

Functional units		ADD/SUB, MUL		
Layout		Type II (checker pattern)		
Operations		64-bit floating point		
Processing structure		Pipelined		
PE structure		FU, T, FU+T, T+T		
LSRDP Size		Small	Medium	Large
No. of inp/out ports		19/12	19/12	38/24
Width/Height		16/16	32/16	64/32
Conf. bit-stream size	Imm. Regs	16*16*64	32*16*64	64*32*64
	ORNs	16*BSS(ORN)	32* BSS(ORN)	64*BSS(ORN)
	PEs	16*16* 2	32*16*2	64*32* 2
ORN	inputs, outputs	22 , 3	26 , 3	26 , 3
	Structure	Cross-bar switch		
	Conn. Type	One-directional		

LSRDP at One Glance (2/2)



Internal memory	Type	Immediate registers
	Size and count	64-bit registers, One reg. for each PE
	Communication mechanism	Serial
External memory	No. of memory modules	16
	Date trans. rate	1800Mbps/pin
	Overall data trans. rate	24 GB/s
	Mem. to LSRDP bus width	64 bit
	Channels per module	Two
Reconf. mechanism	Bit serial configuration through a serial chain	

Preliminary Performance Evaluation



Base processor configuration

Processor type	Out-of-order	
GPP operating frequency	3.2GHz	
Inst. issue width	4 instruction/cc	
Inst. decode width	4 instruction/cc	
Cache configuration	L1 data	64KB(128B Entry, 2way, 2cc)
	L1 instruction	64KB(64B Entry, 1way, 1cc)
	L2 unified	4MB(128B Entry, 4way, 16cc)
Latency of main memory	300cc	
L2 to main memory	Bus width	64 Bytes
	Freq	800 MHz

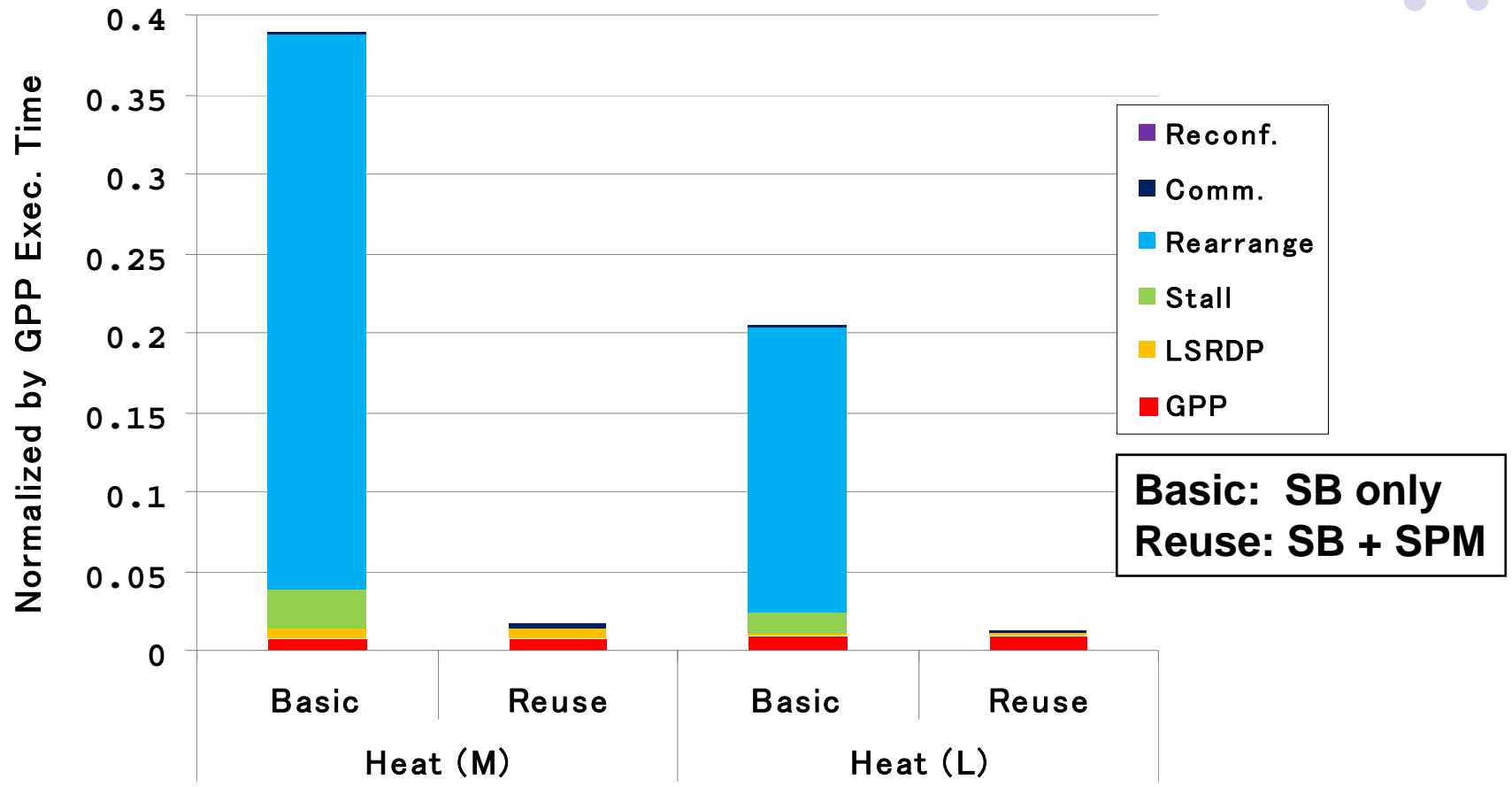
GPP+LSRDP configuration

LSRDP operating frequency	80 GHz
Reconfiguration Latency	1cc
Latency SPM \leftrightarrow LSRDP latency	1cc
Latency Main Memory \leftrightarrow SPM	7500cc
Bandwidth SPM \leftrightarrow LSRDP	Max. 64 * 8 Bytes/cc
Bandwidth Main Memory \leftrightarrow SPM	102.4GB/sec

GPP: Exec. time measurement by means of a processor simulator
LSRDP: Estimation by performance modeling

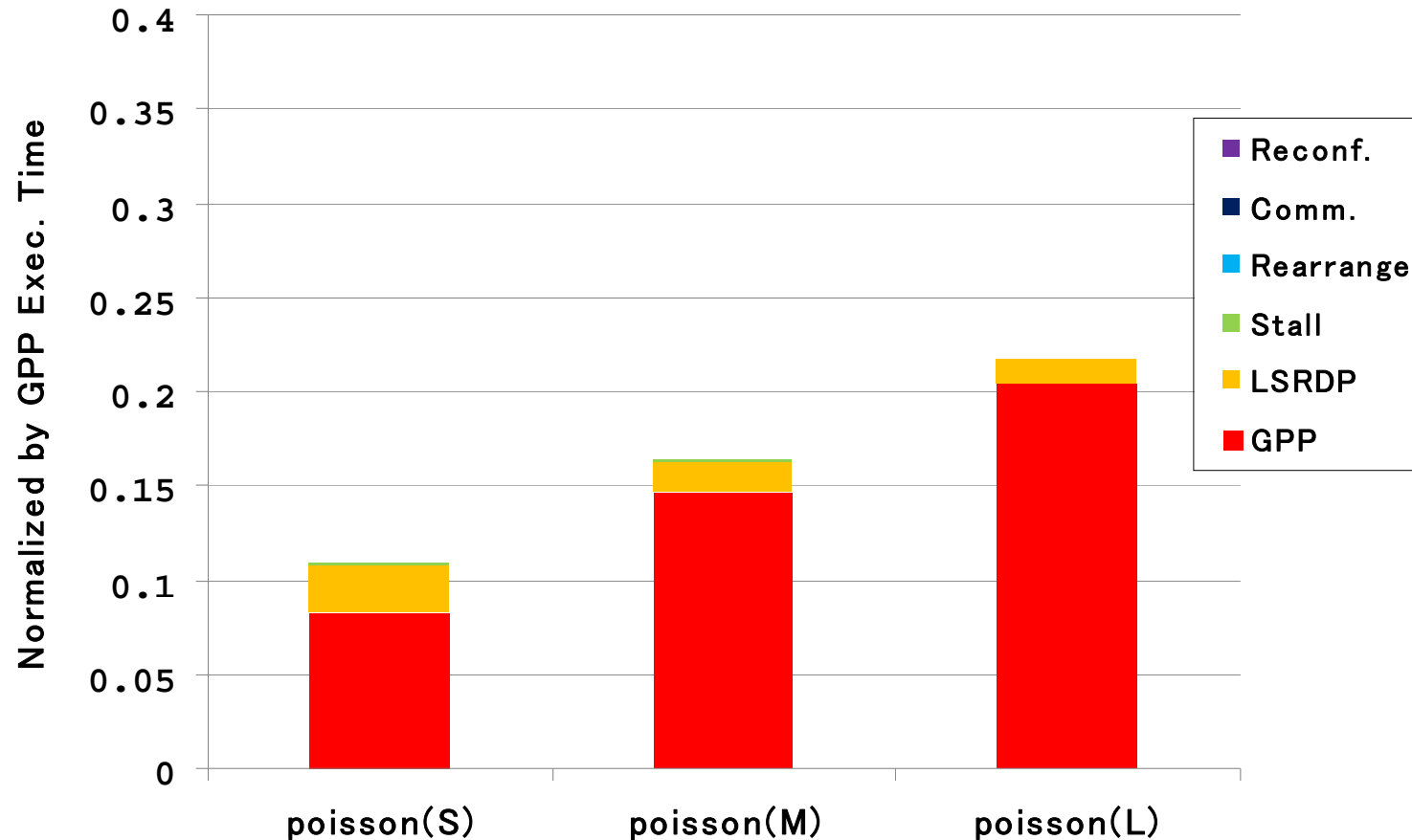


Preliminary Performance Evaluation (Heat)



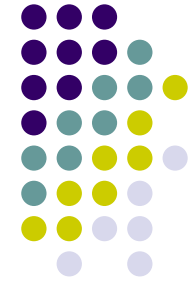
Data reusing is employed to avoid the need for data rearrangement as well as frequently data retrieval from the scratchpad memory.

Preliminary Performance Evaluation (Poisson)



A small fraction is related to processing time on LSRDP and the main fraction concerns to various overhead times as well as the execution time on GPP

Conclusions & Future Work



- A high-performance computer comprising an accelerator (LSRDP) implemented by superconducting circuits was introduced.
- 24 benchmark Data Flow Graphs (DFGs) were manually generated.
- LSRDP micro-architecture is designed based on characteristics of scientific applications via a quantitative approach.
- LSRDP is promising for resolving issues originated from CMOS technology as well as achieving considerable performances.

Future Work:

- To achieve higher performance it is required to *reduce various overhead costs mainly related to data management part.*
- To reduce the implementation cost of LSRDP, we will focus on *reducing maximum connection length and ORN size.*

Acknowledgement

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